



TSMC Reports Third Quarter EPS of NT\$29.43

HSINCHU, Taiwan, R.O.C., Oct. 15, 2026 -- TSMC (TWSE: 2330, NYSE: TSM) today announced consolidated revenue of NT\$1,494.24 billion, net income of NT\$763.06 billion, and diluted earnings per share of NT\$29.43 (US\$4.60 per ADR unit) for the third quarter ended September 30, 2026.

Year-over-year, third quarter revenue increased 50.9%, while net income and diluted EPS both increased 68.7%. Compared to second quarter 2026, third quarter results represented a 17.6% increase in revenue and an 8.0% increase in net income. All figures were prepared in accordance with TIFRS on a consolidated basis.

In US dollars, third quarter revenue was \$46.72 billion, which increased 41.2% year-over-year and increased 16.2% from the previous quarter.

Gross margin for the quarter was 66.4%, operating margin was 58.7%, and net profit margin was 51.1%.

In the third quarter, shipments of 2-nanometer accounted for 8% of total wafer revenue; 3-nanometer accounted for 33%; 5-nanometer accounted for 28%; and 7-nanometer accounted for 10%. Advanced technologies, defined as 7-nanometer and more advanced technologies, accounted for 79% of total wafer revenue.

TSMC's 2026 third quarter consolidated results:

(Unit: NT\$ million, except for EPS)

	3Q26 Amount ^a	3Q25 Amount	YoY Inc. (Dec.) %	2Q26 Amount	QoQ Inc. (Dec.) %
Net sales	1,494,243	989,918	50.9	1,270,381	17.6
Gross profit	992,379	588,543	68.6	860,311	15.4
Income from operations	876,445	500,685	75.0	766,603	14.3
Income before tax	911,039	525,369	73.4	862,430	5.6
Net income	763,064	452,302	68.7	706,562	8.0
EPS (NT\$)	29.43 ^b	17.44 ^c	68.7	27.25 ^b	8.0

a: 3Q2026 figures have not been approved by Board of Directors

b: Based on 25,932 million weighted average outstanding shares

c: Based on 25,930 million weighted average outstanding shares



About TSMC

TSMC pioneered the pure-play foundry business model when it was founded in 1987, and has been the world's leading dedicated semiconductor foundry ever since. The Company supports a thriving ecosystem of global customers and partners with the industry's leading process technologies and portfolio of design enablement solutions to unleash innovation for the global semiconductor industry. With global operations spanning Asia, Europe, and North America, TSMC serves as a committed corporate citizen around the world.

TSMC deployed 305 distinct process technologies, and manufactured 12,682 products for 534 customers in 2025 by providing the broadest range of advanced, specialty and advanced packaging technology services. The Company is headquartered in Hsinchu, Taiwan. For more information please visit <https://www.tsmc.com>.

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